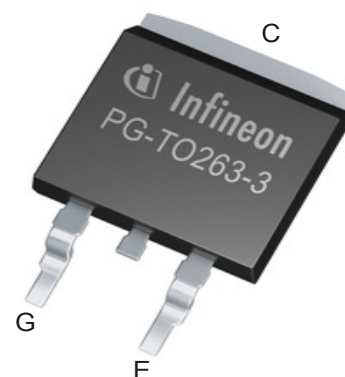
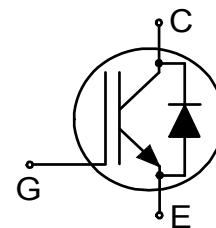


High speed switching series 5th generation

TRENCHSTOP™ 5 high speed switching IGBT copacked with full rated current RAPID 1 anti parallel diode

Features and Benefits:

- High speed H5 technology offering
- Best-in-Class efficiency in hard switching and resonant topologies
 - 650V breakdown voltage
 - Low Q_G
 - IGBT copacked with full rated current RAPID 1 fast antiparallel diode
 - Maximum junction temperature 175°C
 - Pb-free lead plating; RoHS compliant
 - Complete product spectrum and PSpice Models:
<http://www.infineon.com/igbt/>



Potential Applications:

- Energy Generation
 - Solar String Inverter
 - Solar Micro Inverter
- Industrial Power Supplies
 - Industrial SMPS
 - Industrial UPS
- Metal Treatment
 - Welding
- Energy Distribution
 - Energy Storage
- Infrastructure – Charge
 - Charger

Product Validation:

Qualified for industrial applications according to the relevant tests of JEDEC47/20/22



Key Performance and Package Parameters

| Type | V_{CE} | I_C | $V_{CEsat}, T_{vj}=25^{\circ}C$ | T_{vjmax} | Marking | Package |
|-------------|----------|-------|---------------------------------|-------------|---------|------------|
| IKB15N65EH5 | 650V | 15A | 1.65V | 175°C | K15EEH5 | PG-TO263-3 |

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High speed switching series 5th generation

Maximum Ratings

For optimum lifetime and reliability, Infineon recommends operating conditions that do not exceed 80% of the maximum ratings stated in this datasheet.

| Parameter | Symbol | Value | Unit |
|--|-------------|----------------------|--------------------|
| Collector-emitter voltage, $T_{vj} \geq 25^{\circ}\text{C}$ | V_{CE} | 650 | V |
| DC collector current, limited by T_{vjmax} $T_c = 25^{\circ}\text{C}$ $T_c = 100^{\circ}\text{C}$ | I_C | 30.0 18.0 | A |
| Pulsed collector current, t_p limited by T_{vjmax} | I_{Cpuls} | 45.0 | A |
| Turn off safe operating area $V_{CE} \leq 650\text{V}$, $T_{vj} \leq 175^{\circ}\text{C}$, $t_p = 1\mu\text{s}$ | - | 45.0 | A |
| Diode forward current, limited by T_{vjmax} $T_c = 25^{\circ}\text{C}$ $T_c = 100^{\circ}\text{C}$ | I_F | 32.0 21.0 | A |
| Diode pulsed current, t_p limited by T_{vjmax} | I_{Fpuls} | 45.0 | A |
| Gate-emitter voltage Transient Gate-emitter voltage ($t_p \leq 10\mu\text{s}$, $D < 0.010$) | V_{GE} | ± 20 ± 30 | V |
| Power dissipation $T_c = 25^{\circ}\text{C}$ Power dissipation $T_c = 100^{\circ}\text{C}$ | P_{tot} | 105.0 52.5 | W |
| Operating junction temperature | T_{vj} | -40...+175 | $^{\circ}\text{C}$ |
| Storage temperature | T_{stg} | -55...+150 | $^{\circ}\text{C}$ |
| Soldering temperature, reflow soldering (MSL1 according to JEDEC J-STA-020) | | 260 | $^{\circ}\text{C}$ |

Thermal Resistance

| Parameter | Symbol | Conditions | Value | | | Unit |
|---|---------------|------------|-------|------|------|------|
| | | | min. | typ. | max. | |
| R_{th} Characteristics | | | | | | |
| IGBT thermal resistance, junction - case | $R_{th(j-c)}$ | | - | - | 1.40 | K/W |
| Diode thermal resistance, junction - case | $R_{th(j-c)}$ | | - | - | 1.80 | K/W |
| Thermal resistance, min. footprint junction - ambient | $R_{th(j-a)}$ | | - | - | 65 | K/W |
| Thermal resistance, 6cm ² Cu on PCB junction - ambient | $R_{th(j-a)}$ | | - | - | 40 | K/W |

High speed switching series 5th generation

Electrical Characteristic, at $T_{vj} = 25^{\circ}\text{C}$, unless otherwise specified

| Parameter | Symbol | Conditions | Value | | | Unit |
|--------------------------------------|---------------|--|-------|------|------|---------------|
| | | | min. | typ. | max. | |
| Static Characteristic | | | | | | |
| Collector-emitter breakdown voltage | $V_{(BR)CES}$ | $V_{GE} = 0\text{V}, I_C = 0.20\text{mA}$ | 650 | - | - | V |
| Collector-emitter saturation voltage | V_{CESat} | $V_{GE} = 15.0\text{V}, I_C = 15.0\text{A}$ $T_{vj} = 25^{\circ}\text{C}$ $T_{vj} = 125^{\circ}\text{C}$ $T_{vj} = 175^{\circ}\text{C}$ | - | 1.65 | 2.10 | V |
| | | | - | 1.85 | - | |
| | | | - | 1.95 | - | |
| Diode forward voltage | V_F | $V_{GE} = 0\text{V}, I_F = 15.0\text{A}$ $T_{vj} = 25^{\circ}\text{C}$ $T_{vj} = 125^{\circ}\text{C}$ $T_{vj} = 175^{\circ}\text{C}$ | - | 1.45 | 1.70 | V |
| | | | - | 1.42 | - | |
| | | | - | 1.39 | - | |
| Gate-emitter threshold voltage | $V_{GE(th)}$ | $I_C = 0.15\text{mA}, V_{CE} = V_{GE}$ | 3.2 | 4.0 | 4.8 | V |
| Zero gate voltage collector current | I_{CES} | $V_{CE} = 650\text{V}, V_{GE} = 0\text{V}$ $T_{vj} = 25^{\circ}\text{C}$ $T_{vj} = 175^{\circ}\text{C}$ | - | - | 50 | μA |
| | | | - | 1400 | - | |
| Gate-emitter leakage current | I_{GES} | $V_{CE} = 0\text{V}, V_{GE} = 20\text{V}$ | - | - | 100 | nA |
| Transconductance | g_{fs} | $V_{CE} = 20\text{V}, I_C = 15.0\text{A}$ | - | 22.0 | - | S |

Electrical Characteristic, at $T_{vj} = 25^{\circ}\text{C}$, unless otherwise specified

| Parameter | Symbol | Conditions | Value | | | Unit |
|--|-----------|--|-------|------|------|------|
| | | | min. | typ. | max. | |
| Dynamic Characteristic | | | | | | |
| Input capacitance | C_{ies} | $V_{CE} = 25\text{V}, V_{GE} = 0\text{V}, f = 1\text{MHz}$ | - | 930 | - | pF |
| Output capacitance | C_{oes} | | - | 24 | - | |
| Reverse transfer capacitance | C_{res} | | - | 4 | - | |
| Gate charge | Q_G | $V_{CC} = 520\text{V}, I_C = 15.0\text{A},$ $V_{GE} = 15\text{V}$ | - | 38.0 | - | nC |
| Internal emitter inductance measured 5mm (0.197 in.) from case | L_E | | - | 7.0 | - | nH |

Switching Characteristic, Inductive Load

| Parameter | Symbol | Conditions | Value | | | Unit |
|-----------|--------|------------|-------|------|------|------|
| | | | min. | typ. | max. | |

IGBT Characteristic, at $T_{vj} = 25^{\circ}\text{C}$

| | | | | | | |
|------------------------|--------------|---|------|------|----|----|
| Turn-on delay time | $t_{d(on)}$ | $T_{vj} = 25^{\circ}\text{C},$ $V_{CC} = 400\text{V}, I_C = 15.0\text{A},$ $V_{GE} = 0.0/15.0\text{V},$ $R_{G(on)} = 39.0\Omega, R_{G(off)} = 39.0\Omega,$ $L_{\sigma} = 30\text{nH}, C_{\sigma} = 30\text{pF}$ L_{σ}, C_{σ} from Fig. E Energy losses include "tail" and diode reverse recovery. | - | 16 | - | ns |
| Rise time | t_r | | - | 17 | - | ns |
| Turn-off delay time | $t_{d(off)}$ | | - | 145 | - | ns |
| Fall time | t_f | | - | 22 | - | ns |
| Turn-on energy | E_{on} | | - | 0.40 | - | mJ |
| Turn-off energy | E_{off} | | - | 0.08 | - | mJ |
| Total switching energy | E_{ts} | - | 0.48 | - | mJ | |

High speed switching series 5th generation

| | | | | | | |
|------------------------|--------------|--|---|------|---|----|
| Turn-on delay time | $t_{d(on)}$ | $T_{vj} = 25^{\circ}C,$ $V_{CC} = 400V, I_C = 7.5A,$ $V_{GE} = 0.0/15.0V,$ $R_{G(on)} = 39.0\Omega, R_{G(off)} = 39.0\Omega,$ $L\sigma = 30nH, C\sigma = 30pF$ $L\sigma, C\sigma$ from Fig. E Energy losses include "tail" and diode reverse recovery. | - | 15 | - | ns |
| Rise time | t_r | | - | 10 | - | ns |
| Turn-off delay time | $t_{d(off)}$ | | - | 145 | - | ns |
| Fall time | t_f | | - | 27 | - | ns |
| Turn-on energy | E_{on} | | - | 0.18 | - | mJ |
| Turn-off energy | E_{off} | | - | 0.03 | - | mJ |
| Total switching energy | E_{ts} | | - | 0.21 | - | mJ |

Diode Characteristic, at $T_{vj} = 25^{\circ}C$

| | | | | | | |
|--|--------------|--|---|------|---|------------|
| Diode reverse recovery time | t_{rr} | $T_{vj} = 25^{\circ}C,$ $V_R = 400V,$ $I_F = 15.0A,$ $di_F/dt = 600A/\mu s$ | - | 70 | - | ns |
| Diode reverse recovery charge | Q_{rr} | | - | 0.50 | - | μC |
| Diode peak reverse recovery current | I_{rrm} | | - | 10.0 | - | A |
| Diode peak rate of fall of reverse recovery current during t_b | di_{rr}/dt | | - | -600 | - | A/ μs |

| | | | | | | |
|--|--------------|---|---|------|---|------------|
| Diode reverse recovery time | t_{rr} | $T_{vj} = 25^{\circ}C,$ $V_R = 400V,$ $I_F = 7.5A,$ $di_F/dt = 800A/\mu s$ | - | 54 | - | ns |
| Diode reverse recovery charge | Q_{rr} | | - | 0.30 | - | μC |
| Diode peak reverse recovery current | I_{rrm} | | - | 11.0 | - | A |
| Diode peak rate of fall of reverse recovery current during t_b | di_{rr}/dt | | - | -400 | - | A/ μs |

Switching Characteristic, Inductive Load

| Parameter | Symbol | Conditions | Value | | | Unit |
|-----------|--------|------------|-------|------|------|------|
| | | | min. | typ. | max. | |

IGBT Characteristic, at $T_{vj} = 150^{\circ}C$

| | | | | | | |
|------------------------|--------------|--|---|------|---|----|
| Turn-on delay time | $t_{d(on)}$ | $T_{vj} = 150^{\circ}C,$ $V_{CC} = 400V, I_C = 15.0A,$ $V_{GE} = 0.0/15.0V,$ $R_{G(on)} = 39.0\Omega, R_{G(off)} = 39.0\Omega,$ $L\sigma = 30nH, C\sigma = 30pF$ $L\sigma, C\sigma$ from Fig. E Energy losses include "tail" and diode reverse recovery. | - | 16 | - | ns |
| Rise time | t_r | | - | 18 | - | ns |
| Turn-off delay time | $t_{d(off)}$ | | - | 160 | - | ns |
| Fall time | t_f | | - | 20 | - | ns |
| Turn-on energy | E_{on} | | - | 0.53 | - | mJ |
| Turn-off energy | E_{off} | | - | 0.10 | - | mJ |
| Total switching energy | E_{ts} | | - | 0.63 | - | mJ |

| | | | | | | |
|------------------------|--------------|---|---|------|---|----|
| Turn-on delay time | $t_{d(on)}$ | $T_{vj} = 150^{\circ}C,$ $V_{CC} = 400V, I_C = 7.5A,$ $V_{GE} = 0.0/15.0V,$ $R_{G(on)} = 39.0\Omega, R_{G(off)} = 39.0\Omega,$ $L\sigma = 30nH, C\sigma = 30pF$ $L\sigma, C\sigma$ from Fig. E Energy losses include "tail" and diode reverse recovery. | - | 14 | - | ns |
| Rise time | t_r | | - | 10 | - | ns |
| Turn-off delay time | $t_{d(off)}$ | | - | 160 | - | ns |
| Fall time | t_f | | - | 28 | - | ns |
| Turn-on energy | E_{on} | | - | 0.27 | - | mJ |
| Turn-off energy | E_{off} | | - | 0.04 | - | mJ |
| Total switching energy | E_{ts} | | - | 0.31 | - | mJ |

High speed switching series 5th generation

Diode Characteristic, at $T_{vj} = 150^{\circ}\text{C}$

| | | | | | | |
|--|--------------|---|---|------|---|------------------------|
| Diode reverse recovery time | t_{rr} | $T_{vj} = 150^{\circ}\text{C},$ $V_R = 400\text{V},$ $I_F = 15.0\text{A},$ $di_F/dt = 550\text{A}/\mu\text{s}$ | - | 100 | - | ns |
| Diode reverse recovery charge | Q_{rr} | | - | 0.92 | - | μC |
| Diode peak reverse recovery current | I_{rrm} | | - | 13.5 | - | A |
| Diode peak rate of fall of reverse recovery current during t_b | di_{rr}/dt | | - | -573 | - | $\text{A}/\mu\text{s}$ |
| Diode reverse recovery time | t_{rr} | $T_{vj} = 150^{\circ}\text{C},$ $V_R = 400\text{V},$ $I_F = 7.5\text{A},$ $di_F/dt = 740\text{A}/\mu\text{s}$ | - | 75 | - | ns |
| Diode reverse recovery charge | Q_{rr} | | - | 0.62 | - | μC |
| Diode peak reverse recovery current | I_{rrm} | | - | 13.0 | - | A |
| Diode peak rate of fall of reverse recovery current during t_b | di_{rr}/dt | | - | -550 | - | $\text{A}/\mu\text{s}$ |

High speed switching series 5th generation

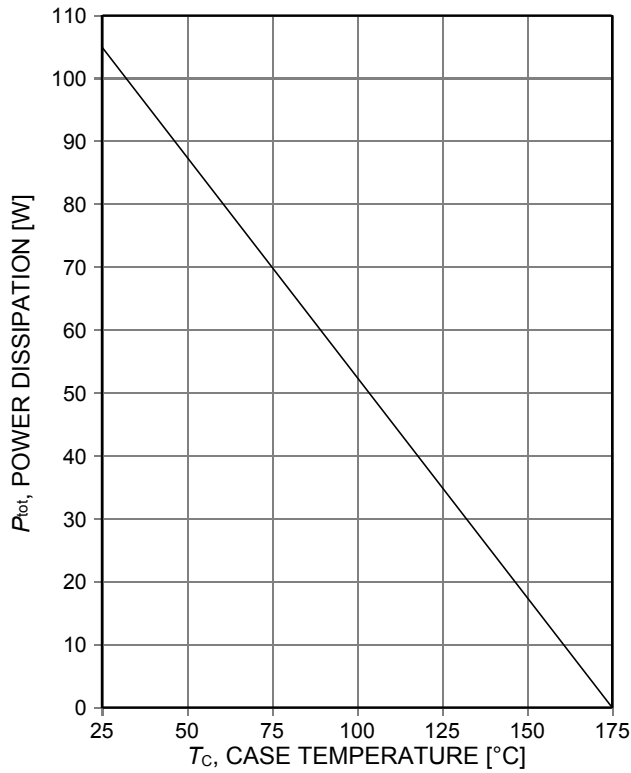


Figure 1. Power dissipation as a function of case temperature ($T_{vj} \leq 175^{\circ}\text{C}$)

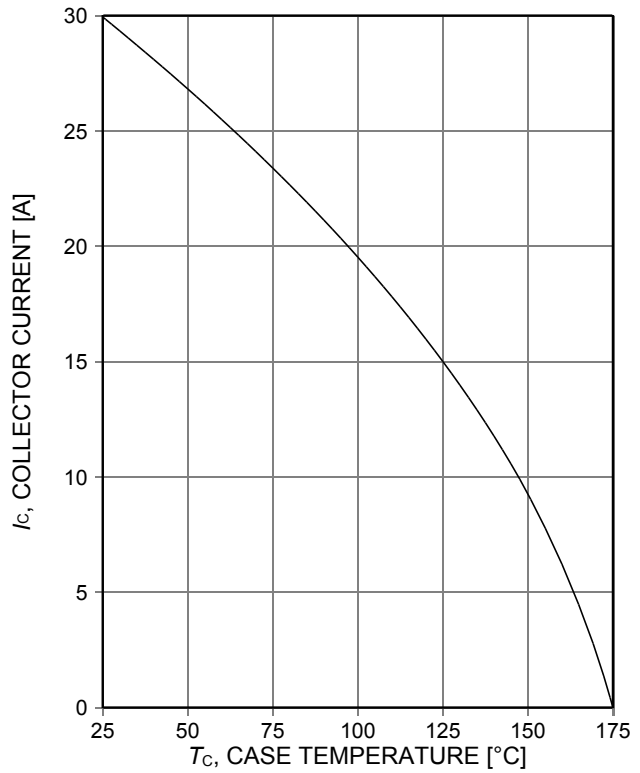


Figure 2. Collector current as a function of case temperature ($V_{GE} \geq 15\text{V}$, $T_{vj} \leq 175^{\circ}\text{C}$)

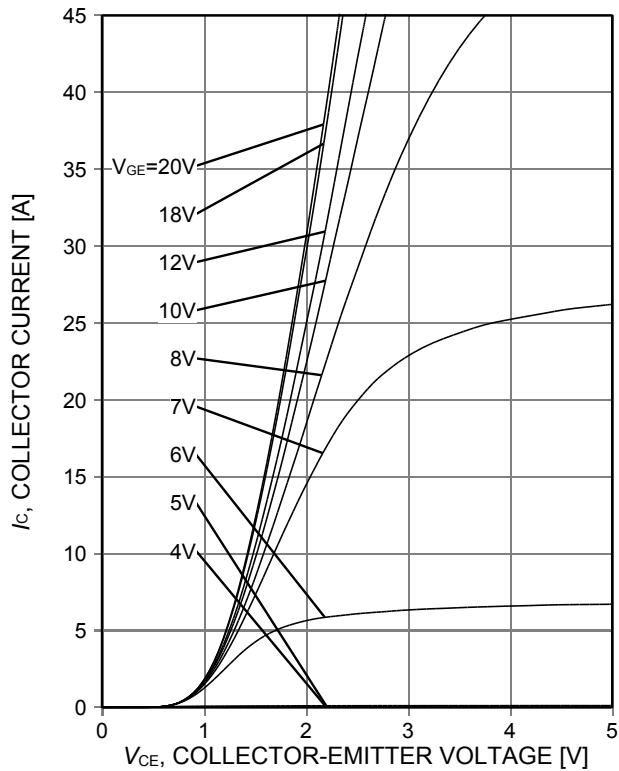


Figure 3. Typical output characteristic ($T_{vj} = 25^{\circ}\text{C}$)

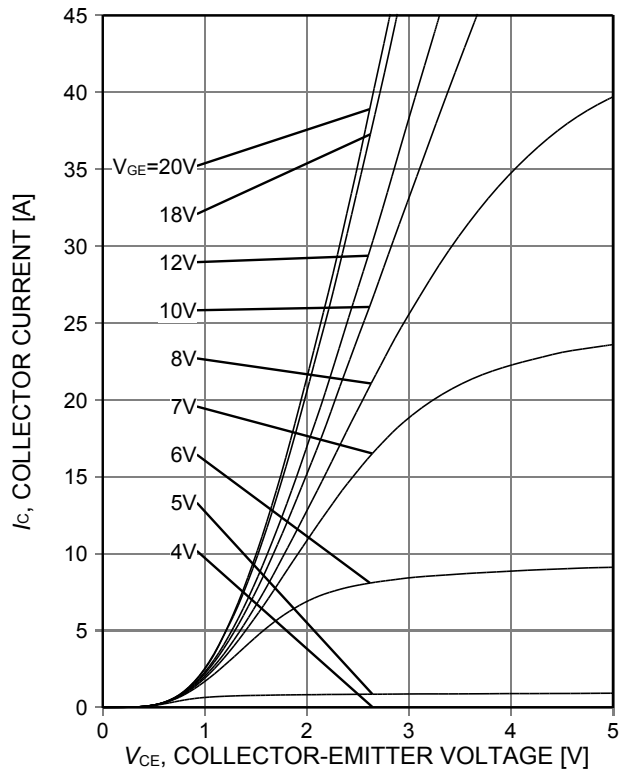


Figure 4. Typical output characteristic ($T_{vj} = 150^{\circ}\text{C}$)

High speed switching series 5th generation

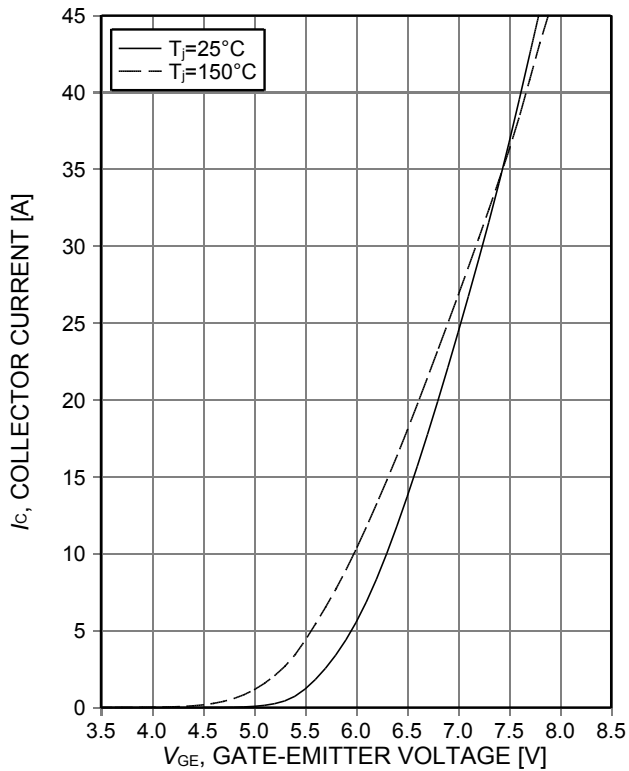


Figure 5. **Typical transfer characteristic**
($V_{CE}=20V$)

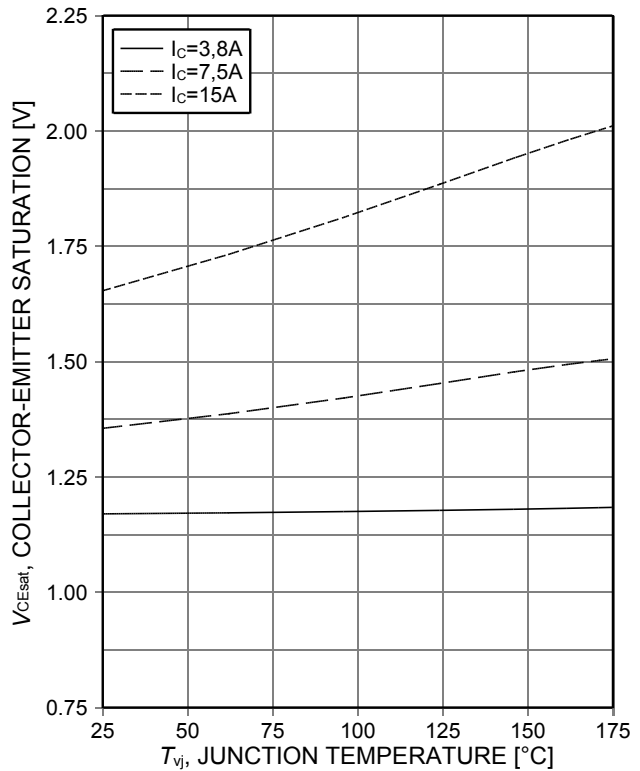


Figure 6. **Typical collector-emitter saturation voltage as a function of junction temperature**
($V_{GE}=15V$)

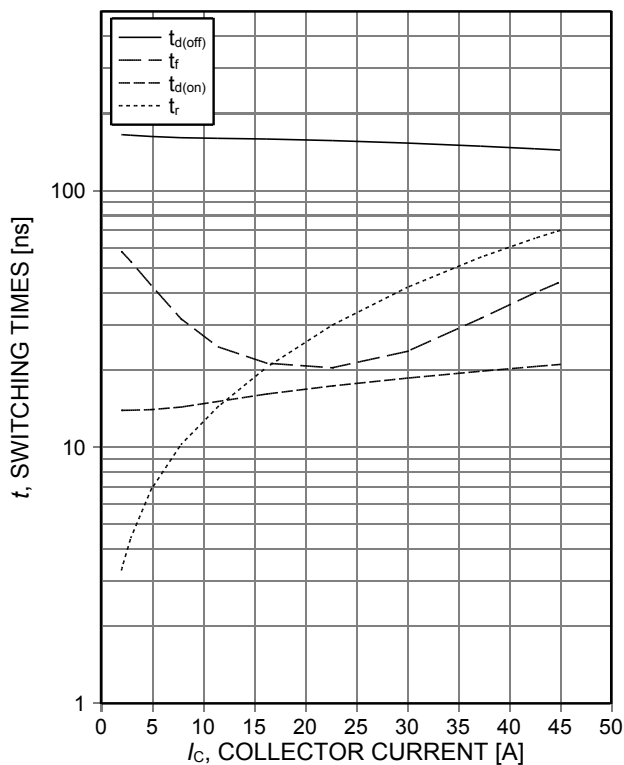


Figure 7. **Typical switching times as a function of collector current**
(inductive load, $T_{vj}=150^{\circ}C$, $V_{CE}=400V$, $V_{GE}=15/0V$, $R_G=39\Omega$, Dynamic test circuit in Figure E)

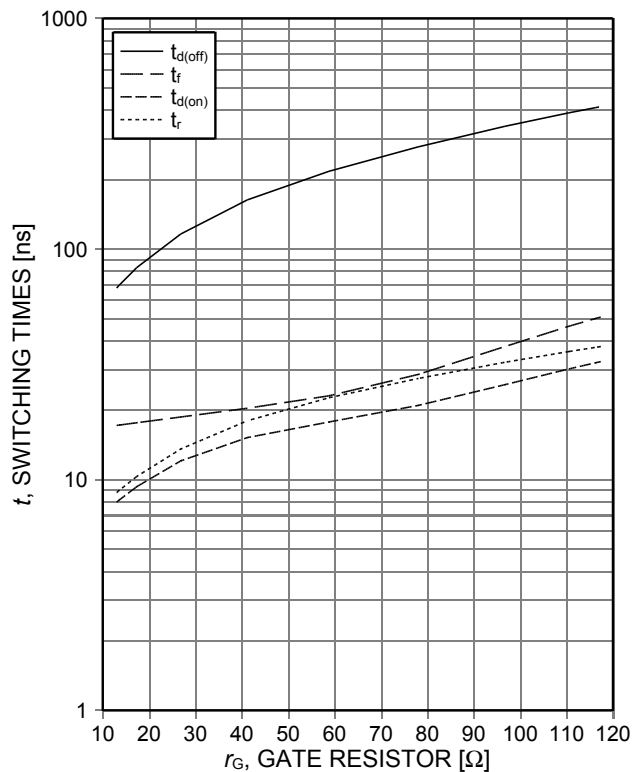


Figure 8. **Typical switching times as a function of gate resistor**
(inductive load, $T_{vj}=150^{\circ}C$, $V_{CE}=400V$, $V_{GE}=15/0V$, $I_C=15A$, Dynamic test circuit in Figure E)

High speed switching series 5th generation

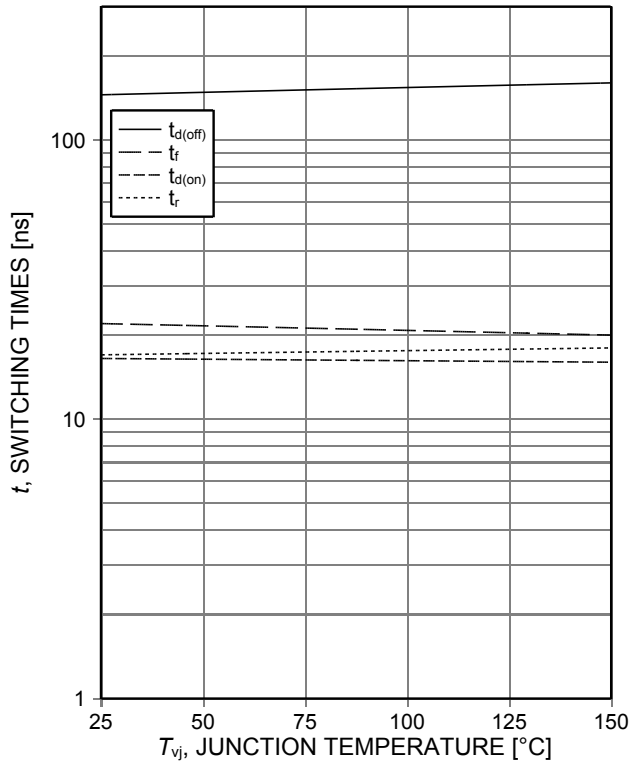


Figure 9. **Typical switching times as a function of junction temperature**
 (inductive load, $V_{CE}=400V$, $V_{GE}=15/0V$, $I_C=15A$, $r_G=39\Omega$, Dynamic test circuit in Figure E)

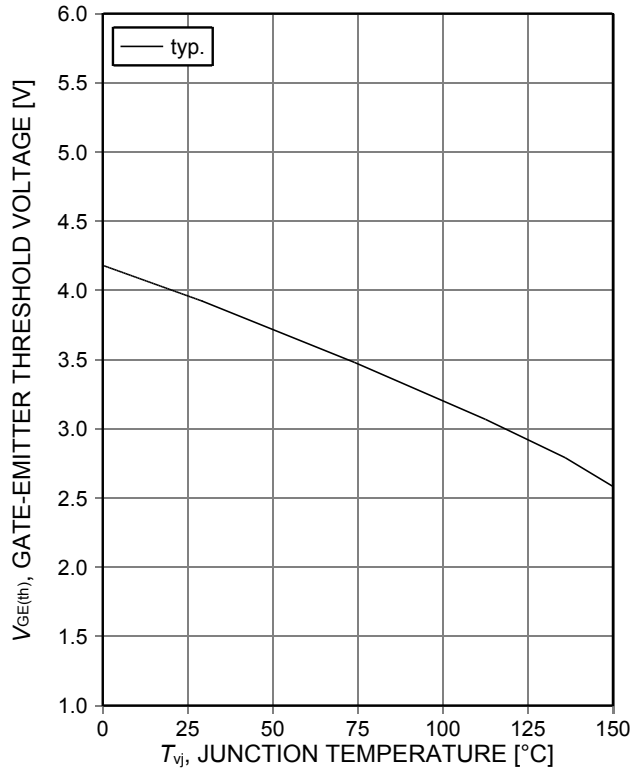


Figure 10. **Gate-emitter threshold voltage as a function of junction temperature**
 ($I_C=0.15mA$)

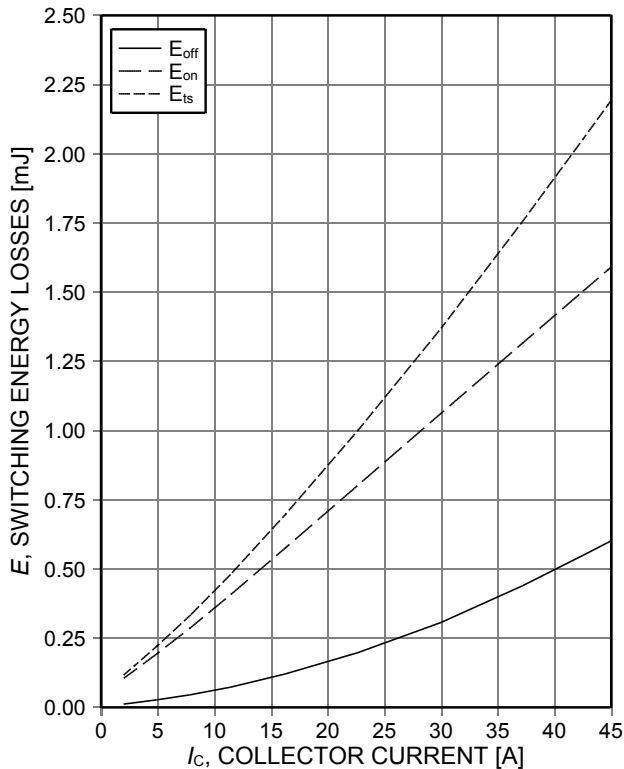


Figure 11. **Typical switching energy losses as a function of collector current**
 (inductive load, $T_{vj}=150^\circ C$, $V_{CE}=400V$, $V_{GE}=15/0V$, $R_G=39\Omega$, Dynamic test circuit in Figure E)

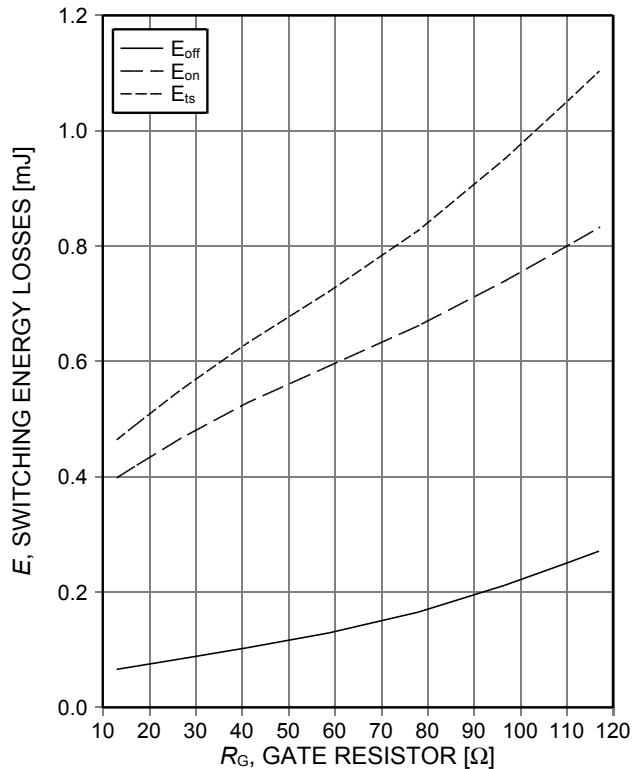


Figure 12. **Typical switching energy losses as a function of gate resistor**
 (inductive load, $T_{vj}=150^\circ C$, $V_{CE}=400V$, $V_{GE}=15/0V$, $I_C=15A$, Dynamic test circuit in Figure E)

High speed switching series 5th generation

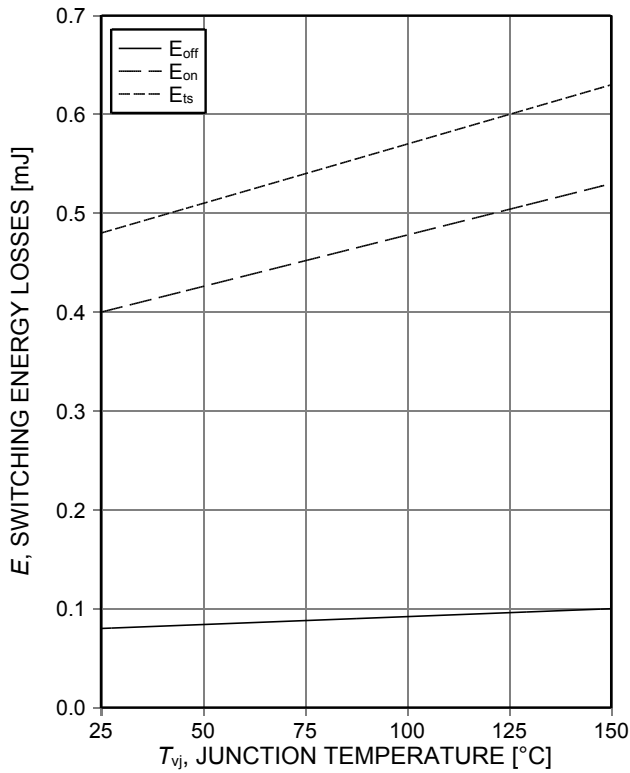


Figure 13. **Typical switching energy losses as a function of junction temperature** (inductive load, $V_{CE}=400V$, $V_{GE}=15/0V$, $I_C=15A$, $R_G=39\Omega$, Dynamic test circuit in Figure E)

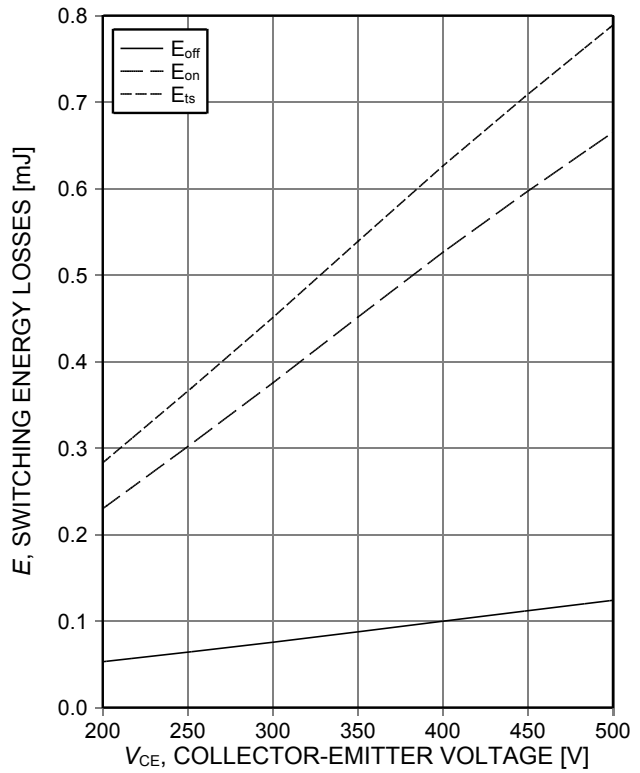


Figure 14. **Typical switching energy losses as a function of collector emitter voltage** (inductive load, $T_{vj}=150^\circ C$, $V_{GE}=15/0V$, $I_C=15A$, $r_G=39\Omega$, Dynamic test circuit in Figure E)

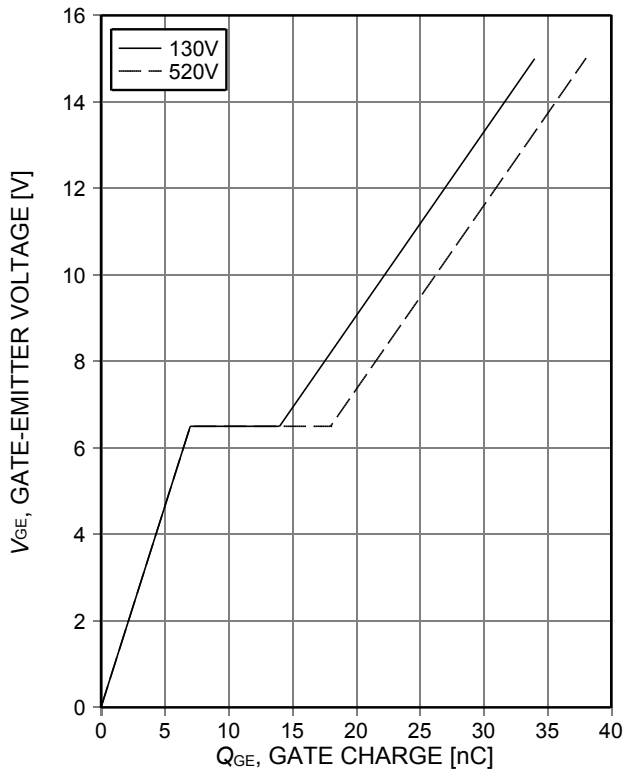


Figure 15. **Typical gate charge** ($I_C=15A$)

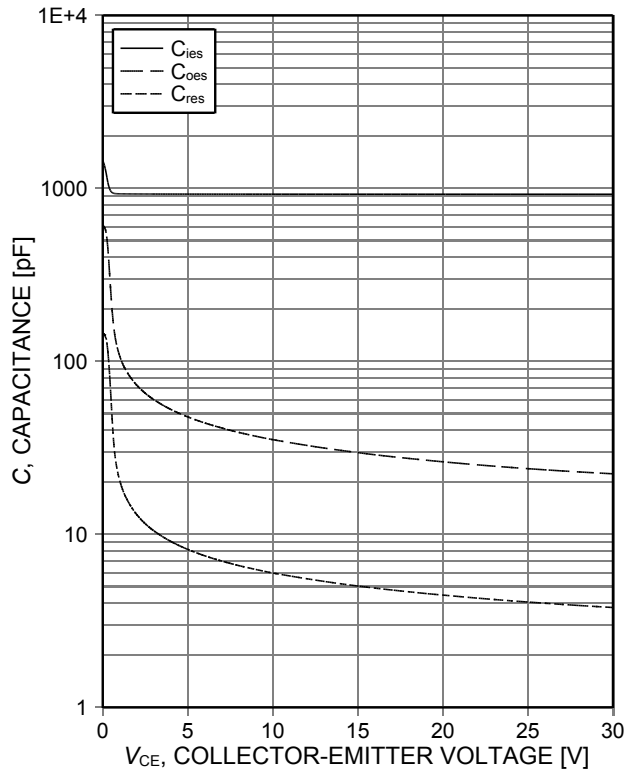


Figure 16. **Typical capacitance as a function of collector-emitter voltage** ($V_{GE}=0V$, $f=1MHz$)

High speed switching series 5th generation

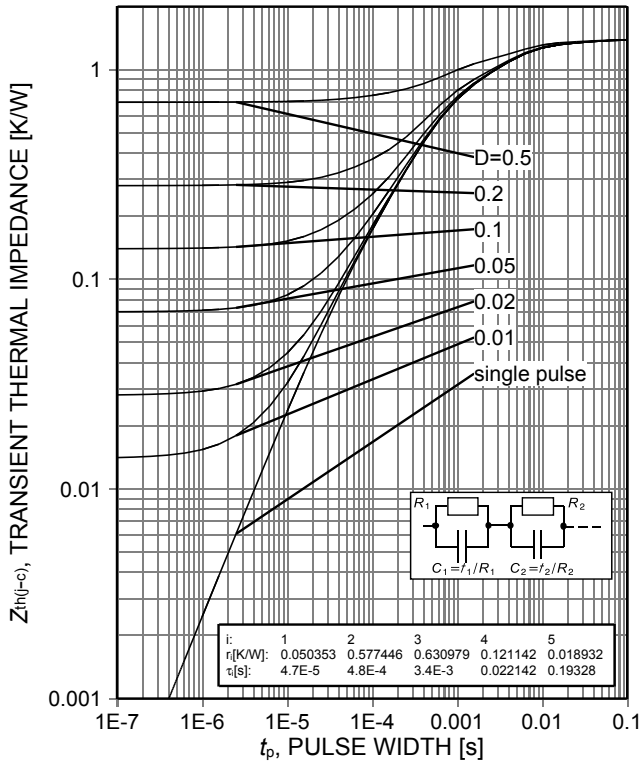


Figure 17. IGBT transient thermal impedance ($D=t_p/T$)

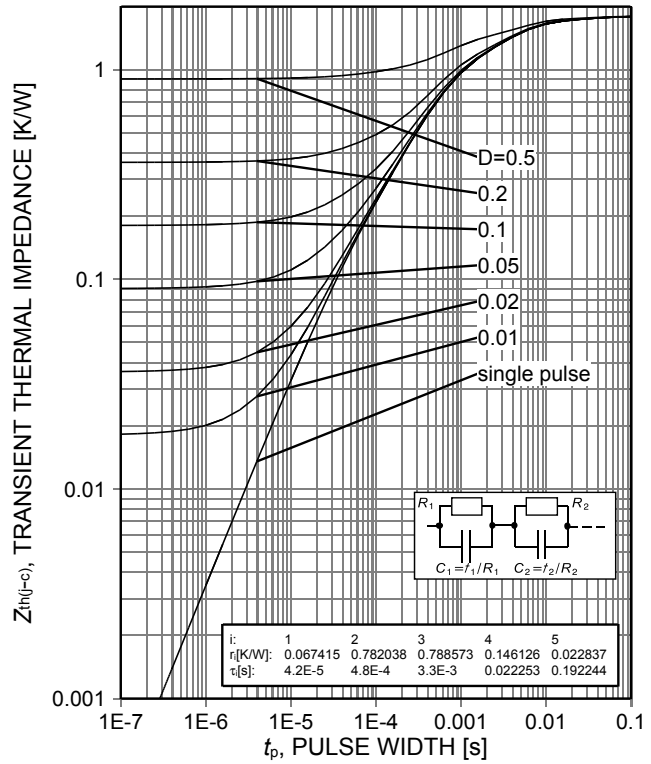


Figure 18. Diode transient thermal impedance as a function of pulse width ($D=t_p/T$)

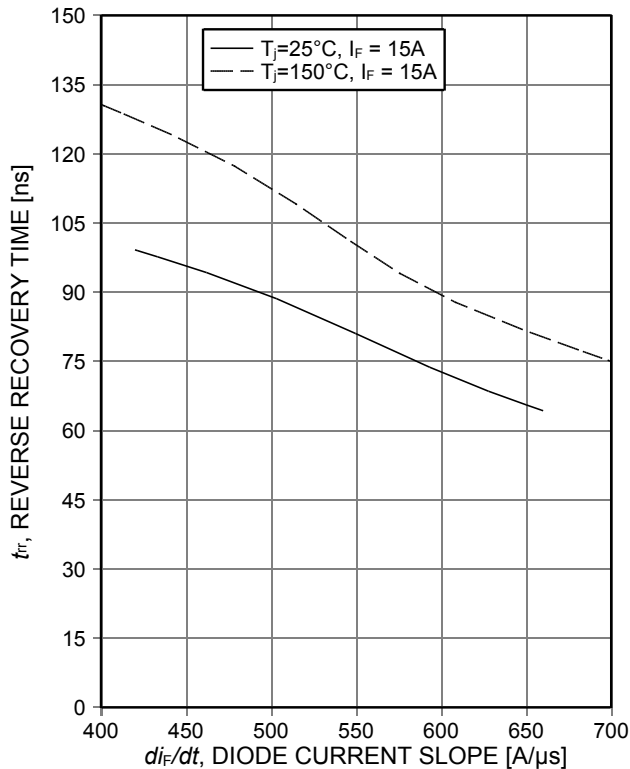


Figure 19. Typical reverse recovery time as a function of diode current slope ($V_R=400V$)

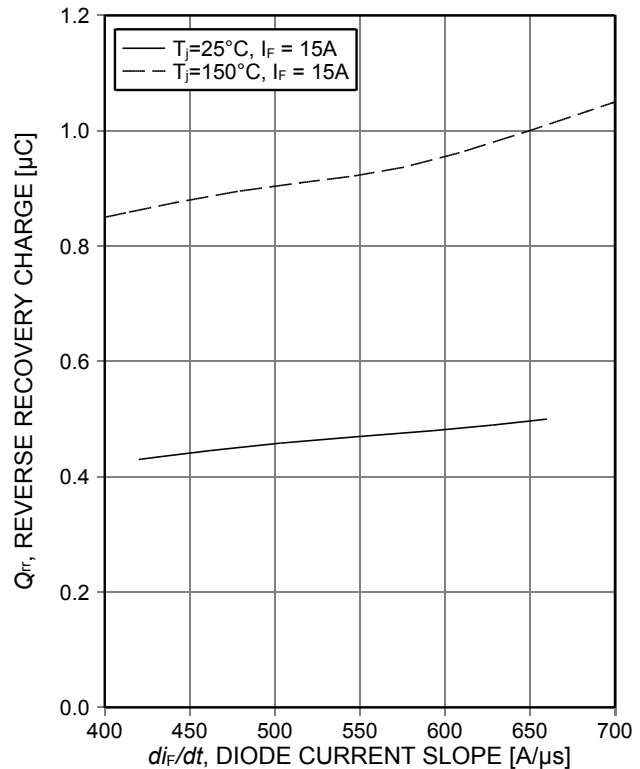


Figure 20. Typical reverse recovery charge as a function of diode current slope ($V_R=400V$)

High speed switching series 5th generation

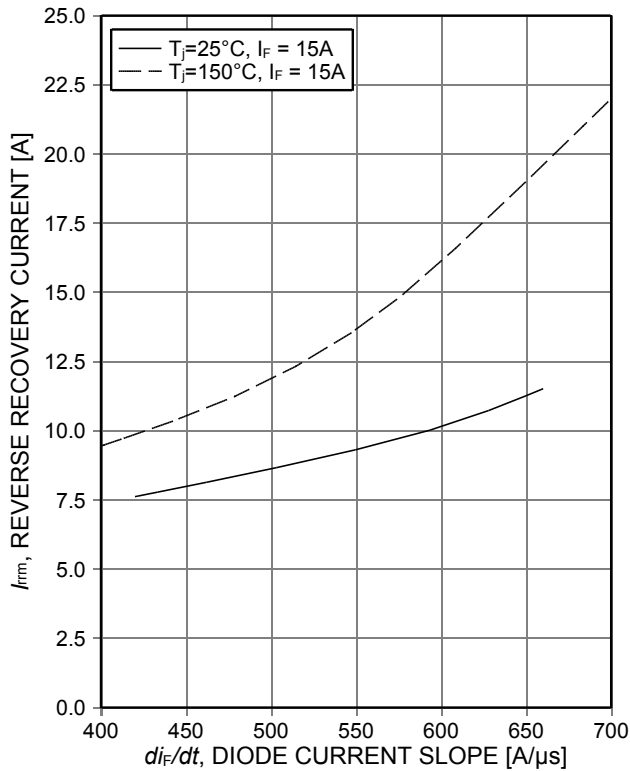


Figure 21. Typical peak reverse recovery current as a function of diode current slope (VR=400V)

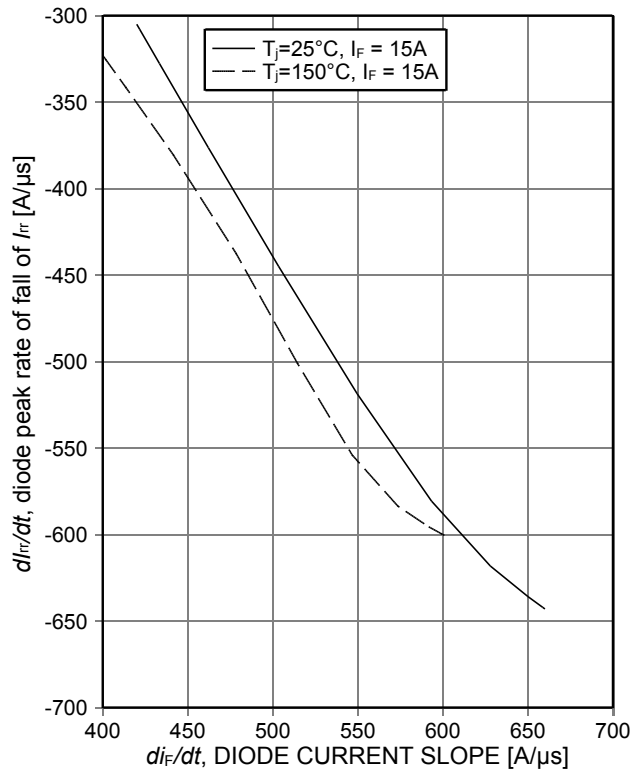


Figure 22. Typical diode peak rate of fall of reverse recovery current as a function of diode current slope (VR=400V)

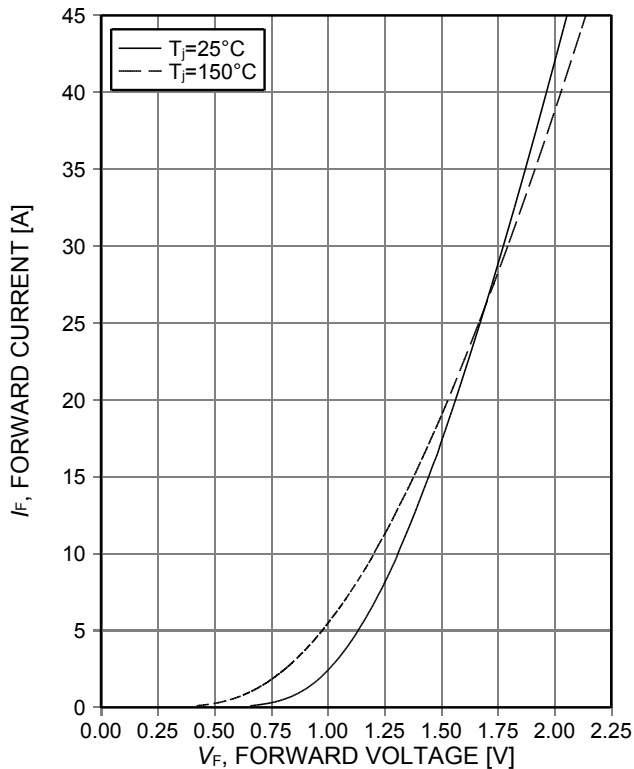


Figure 23. Typical diode forward current as a function of forward voltage

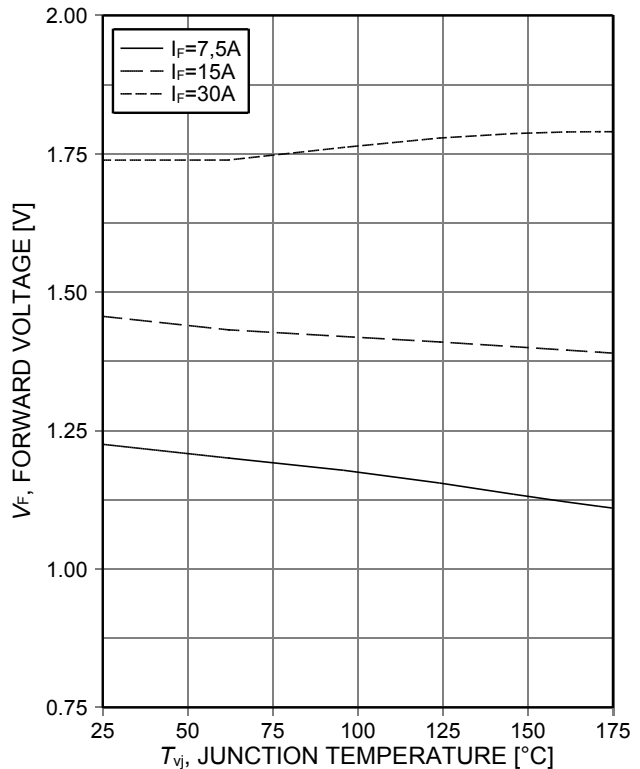
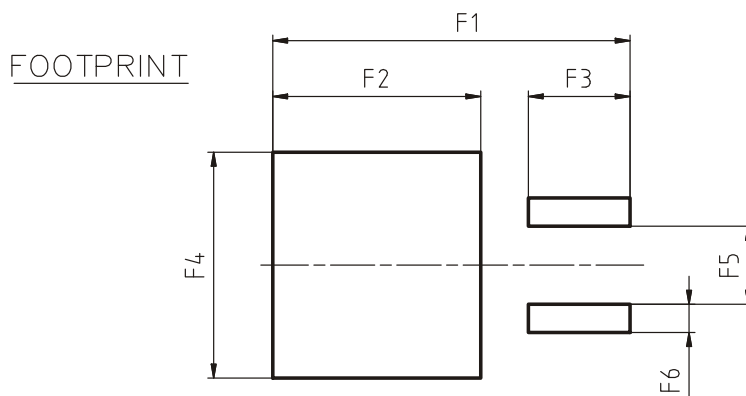
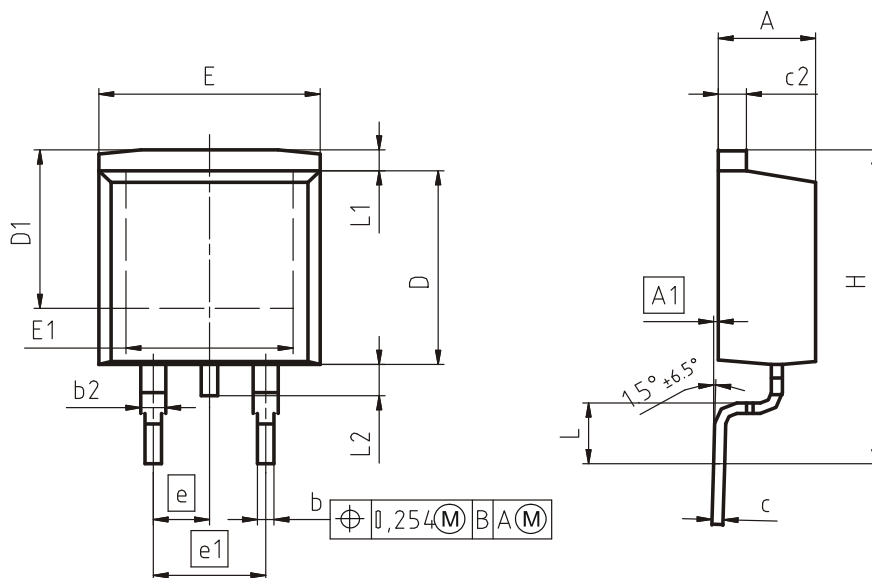


Figure 24. Typical diode forward voltage as a function of junction temperature

Package Drawing PG-TO263-3



| DIM | MILLIMETERS | | INCHES | |
|-----|-------------|-------|--------|-------|
| | MIN | MAX | MIN | MAX |
| A | 4.30 | 4.57 | 0.169 | 0.180 |
| A1 | 0.00 | 0.25 | 0.000 | 0.010 |
| b | 0.65 | 0.85 | 0.026 | 0.033 |
| b2 | 0.95 | 1.15 | 0.037 | 0.045 |
| c | 0.33 | 0.65 | 0.013 | 0.026 |
| c2 | 1.17 | 1.40 | 0.046 | 0.055 |
| D | 8.51 | 9.45 | 0.335 | 0.372 |
| D1 | 7.10 | 7.90 | 0.280 | 0.311 |
| E | 9.80 | 10.31 | 0.386 | 0.406 |
| E1 | 6.50 | 8.60 | 0.256 | 0.339 |
| e | 2.54 | | 0.100 | |
| e1 | 5.08 | | 0.200 | |
| N | 2 | | 2 | |
| H | 14.61 | 15.88 | 0.575 | 0.625 |
| L | 2.29 | 3.00 | 0.090 | 0.118 |
| L1 | 0.70 | 1.60 | 0.028 | 0.063 |
| L2 | 1.00 | 1.78 | 0.039 | 0.070 |
| F1 | 16.05 | 16.25 | 0.632 | 0.640 |
| F2 | 9.30 | 9.50 | 0.366 | 0.374 |
| F3 | 4.50 | 4.70 | 0.177 | 0.185 |
| F4 | 10.70 | 10.90 | 0.421 | 0.429 |
| F5 | 3.65 | 3.85 | 0.144 | 0.152 |
| F6 | 1.25 | 1.45 | 0.049 | 0.057 |

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SCALE

7.5mm

EUROPEAN PROJECTION

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01

Testing Conditions



Figure A. Definition of switching times



Figure B. Definition of switching losses



Figure C. Definition of diode switching characteristics



Figure D. Thermal equivalent circuit



Figure E. **Dynamic test circuit**
Parasitic inductance L_{σ} ,
parasitic capacitor C_{σ} ,
relief capacitor C_r ,
(only for ZVT switching)

High speed switching series 5th generation

Revision History

IKB15N65EH5

Revision: 2018-01-11, Rev. 2.1

Previous Revision

| Revision | Date | Subjects (major changes since last revision) |
|----------|------------|--|
| 2.1 | 2018-01-11 | Final data sheet |

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